SV 7.62IT/04/90MF2 3.5SN BK BX TB

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

www.weidmueller.com

90° male header with soldered flange fastening with 7.62 pitch for 400 V IT power networks according to IEC 61800-5-1.
UL approval as per UL840 600 V.
Meets the extended requirements on 5.5 mm touch safety for IT power networks as per IEC 61800-5-1 for 400 V to earth when combined with female header BVZ 7.62 IT...
Without a female header, the mating profile guarantees minimum touch safety of >3 mm with 20 N pressure on the test finger.
The automatically locking middle flange which can optionally also be screwed, reduces space requirements by one pitch width in comparison with conventional solutions.
On request: available with screw flange or without flange.

General ordering data

Version	PCB plug-in connector, male header, closed side, Middle flange, THT solder connection, 7.62 mm, Number of poles: 4, 90°, Solder pin length (l): 3.5 mm, black, Box
Order No.	2544910000
Type	SV 7.62IT/04/90MF2 3.5SN BK BX TB
GTIN (EAN)	4050118555059
Qty.	48 pc(s).
Product data	IEC: 1000 V / 41 A UL: 300 V / 40.5 A
Packaging	Box

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Technical data

Dimensions and weights

Net weight	9.931 g

System specifications

Product family	OMNIMATE Power - series BV/SV 7.62IT	Type of connection	Board connection
Mounting onto the PCB	THT solder connection	Pitch in mm (P)	7.62 mm
Pitch in inches (P)	0.3 inch	Outgoing elbow	90°
Number of poles	4	Number of solder pins per pole	2
Solder pin length (l)	3.5 mm	Solder pin length tolerance	+0.1 / -0.3 mm
Solder pin dimensions	0.8 x 1.0 mm	Solder eyelet hole diameter (D)	1.3 mm
Solder eyelet hole diameter tolerance (D)	+ 0,1 mm	L1 in mm	30.48 mm
L1 in inches	1.2 inch	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	Touch-safe above the printed circuit board	Touch-safe protection acc. to DIN VDE 0470	IP 20
Volume resistance	2.00 mΩ	Can be coded	Yes

Material data

Insulating material	PA GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	II
Comparative Tracking Index (CTI)	≥ 500	UL 94 flammability rating	V-0
Contact material	Copper alloy	Layer structure of solder connection	1...3 µm Ni / 4...6 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 4...6 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	130 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	130 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	41 A
Rated current, max. number of poles (Tu=20°C)	41 A	Rated current, min. number of poles (Tu=40°C)	41 A
Rated current, max. number of poles (Tu=40°C)	41 A	Rated voltage for surge voltage class / pollution degree II/2	1,000 V
Rated voltage for surge voltage class / pollution degree III/2	630 V	Rated voltage for surge voltage class / pollution degree III/3	630 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	6 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	6 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	6 kV	Short-time withstand current resistance	3 x 1s with 420 A

Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group C / CSA)	300 V
Rated voltage (Use group D / CSA)	600 V	Rated current (Use group B / CSA)	35 A
Rated current (Use group C / CSA)	35 A	Rated current (Use group D / CSA)	5 A

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Technical data

Rated data acc. to UL 1059

Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group C / UL 1059)	300 V
Rated voltage (Use group D / UL 1059)	600 V	Rated current (Use group B / UL 1059)	40.5 A
Rated current (Use group C / UL 1059)	40.5 A	Rated current (Use group D / UL 1059)	5 A
Clearance distance, min.	6.9 mm	Creepage distance, min.	9.6 mm

Packing

Packaging	Box	VPE length	350 mm
VPE width	135 mm	VPE height	35 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note

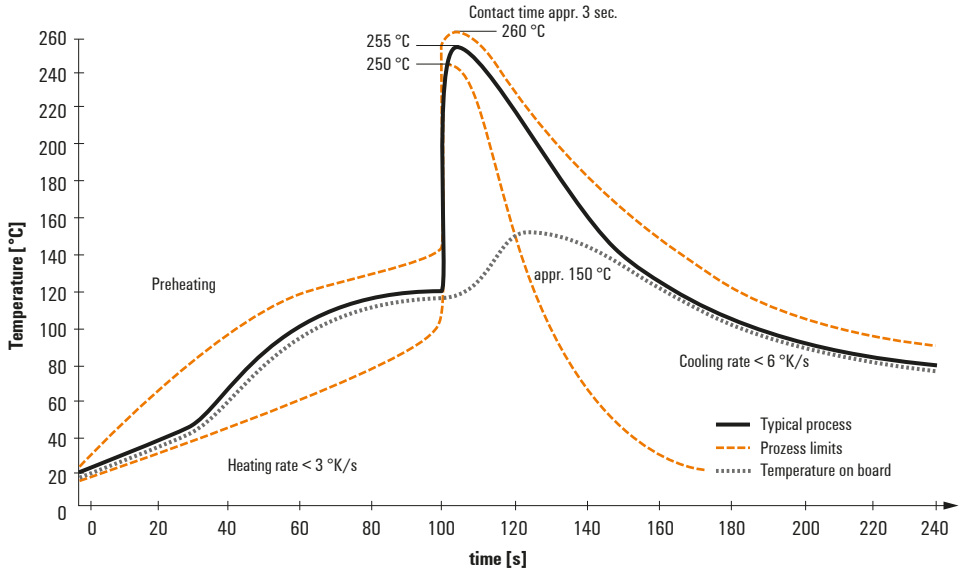
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Additional colours on request • Rated current related to rated cross-section & min. No. of poles. • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • MFX and MSFX: X= Position of the middle flange e.g. MF2, MSF3 • Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Wave Solder Profile

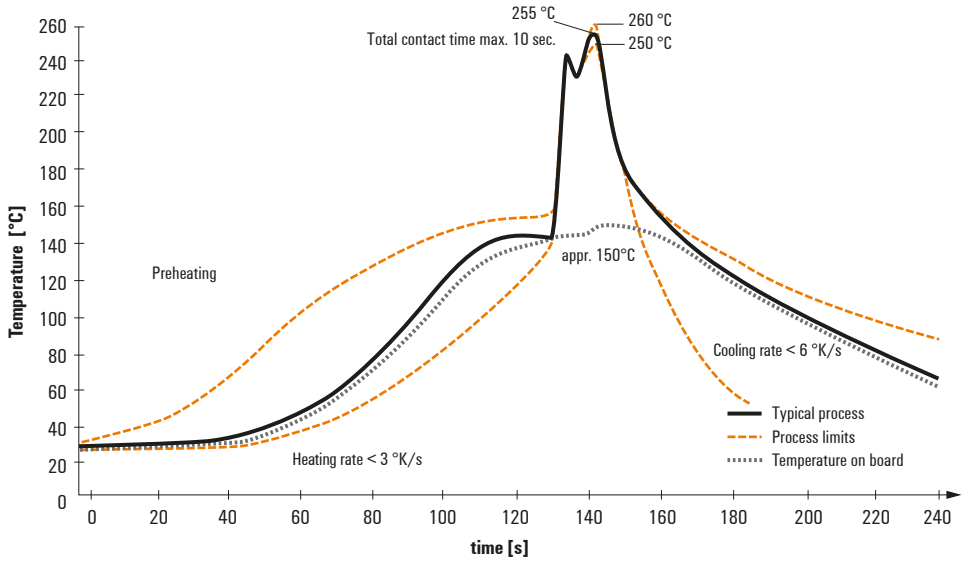
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:
- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.